

**Notice of References Cited**

		Application/Control No.	Applicant(s)/Patent Under Reexamination SAGUES ET AL.	
		10/071,870	Examiner Gopal C. Ray	
			Art Unit 2111	Page 1 of 1

**U.S. PATENT DOCUMENTS**

*		Document Number Country Code-Number-Kind Code	Date MM-YYYY	Name	Classification
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	B	US-5,630,170	05-1997	Koizumi et al.	710/12
	C	US-5,701,515	12-1997	Gradeler, Eric J.	710/14
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	E	US-6,349,235	02-2002	Gibart et al.	700/11
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	K	US-			
	L	US-			
	M	US-			

**FOREIGN PATENT DOCUMENTS**

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**NON-PATENT DOCUMENTS**

*		Include as applicable: Author, Title Date, Publisher, Edition or Volume, Pertinent Pages)
	U	"High-density and high-pin count flexible SMD connector for high-speed data bus" by Sasaki, S; Kishimoto, T. (abstract only)
	V	"High performance mainframe computer cables" by Beaman, B. (abstract only)
	W	
	X	

\*A copy of this reference is not being furnished with this Office action. (See MPEP § 707.05(a).)  
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